

## • General Description

The AGM15T06C combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{\text{DS(ON)}}$ .

This device is ideal for load switch and battery protection applications.

#### Features

- Advance high cell density Trench technology
- Low R<sub>DS(ON)</sub> to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance
- 100% Avalanche tested
- 100% DVDS tested

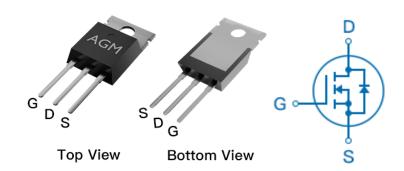
## Application

- MB/VGA Vcore
- SMPS 2<sup>nd</sup> Synchronous Rectifier
- POL application
- BLDC Motor driver

# **Product Summary**

BVDSS	RDSON	ID
150V	6.5mΩ	140A

# **TO-220 Pin Configuration**



## **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM15T06C	AGM15T06C	TO-220			1000

## Table 1. Absolute Maximum Ratings (TA=25℃)

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	150	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(Tc=25℃) (Note 1)	140	А
	Drain Current-Continuous(Tc=100℃)	95	А
IDM (pluse)	Drain Current-Pulsed (Note 2)	560	А
PD	Maximum Power Dissipation(Tc=25℃)	250	W
	Maximum Power Dissipation(Tc=100℃)	100	w
EAS	Avalanche energy (Note 3)	924	mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	$^{\circ}$ C

#### Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) <sup>1</sup>		60	°C/W
RøJC	Thermal Resistance Junction-Case <sup>1</sup>		0.5	°C/W



Table 3. Electrical Characteristics (TJ=25 ℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off States						
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250μA	150			V
IDSS	Zero Gate Voltage Drain Current	VDS=150V,VGS=0V			1	μΑ
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V			±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=250μA	2.0	2.8	4.0	V
gFS	Forward Transconductance	VDS=5V,ID=10A		18		S
RDS(on)	Drain-Source On-State Resistance	VGS=10V, ID=20A		6.5	7.5	mΩ
Dynamic	Characteristics					
Ciss	Input Capacitance	VDS=75V,VGS=0V,		5025		pF
Coss	Output Capacitance	F=1MHZ		410		pF
Crss	Reverse Transfer Capacitance			10		pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz				Ω
Switching	j Times					
td(on)	Turn-on Delay Time			25		nS
tr	Turn-on Rise Time	VGS=10V,VDS=75V,		31		nS
td(off)	Turn-Off Delay Time	ID=80A,RGEN=6Ω		60		nS
tf	Turn-Off Fall Time			20		nS
Qg	Total Gate Charge			19		nC
Qgs	Gate-Source Charge	VGS=10V, VDS=75V, ID=80A		11		nC
Qgd	Gate-Drain Charge	- 15-00/(		12		nC
Source-Drain Diode Characteristics						
ISD	Source-Drain Current(Body Diode)				140	А
VSD	Forward on Voltage	VGS=0V,IS=10A			1.2	V
trr	Reverse Recovery Time	IF=10A , dI/dt=100A/μs ,		45		ns
Qrr	Reverse Recovery Charge	TJ=25℃		12		nc

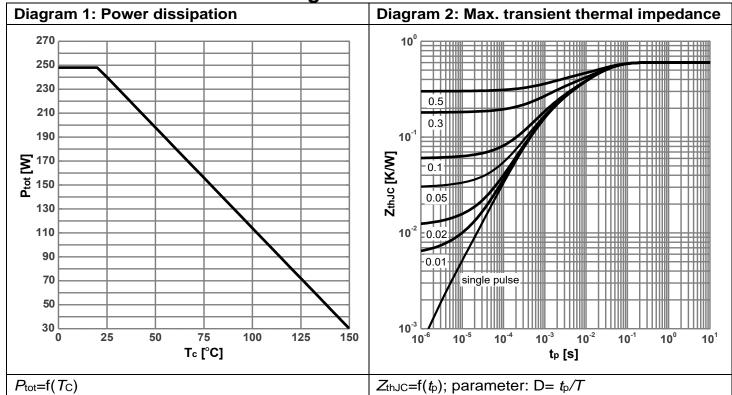
Notes 1. The maximum current rating is package limited.

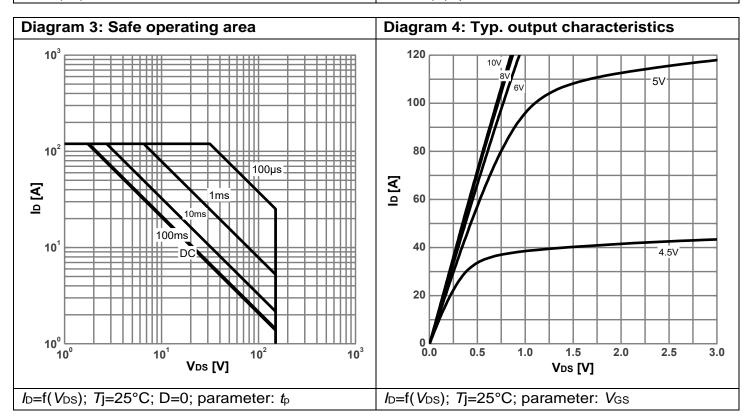
Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

Notes 3.EAS condition: TJ=25  $^{\circ}$ C,VDD=50V,Vgs=10V,ID=43A, L=1mH,RG=25ohm

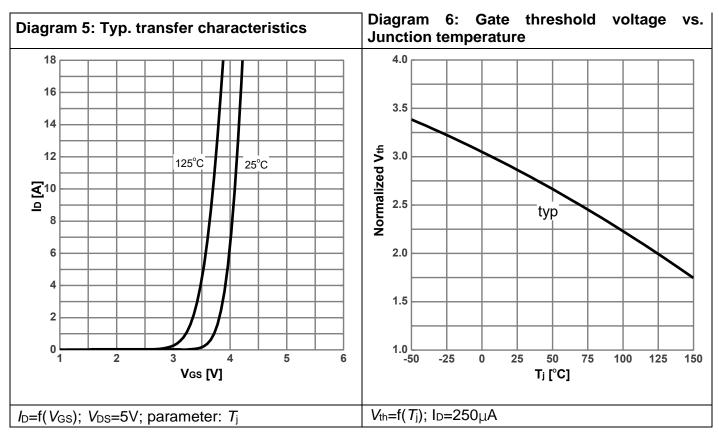


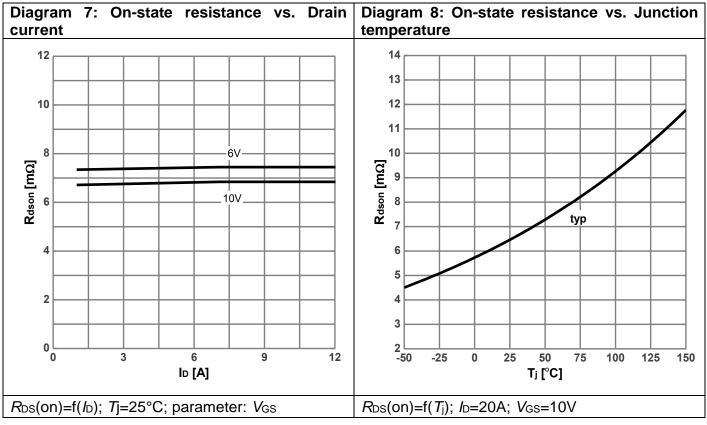
**Electrical characteristics diagrams** 



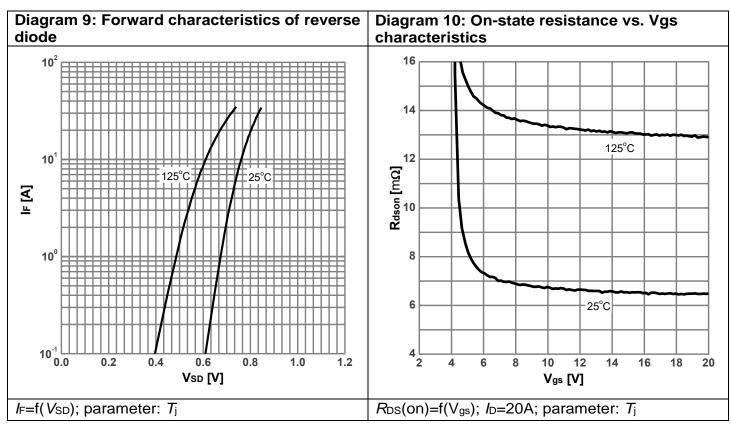


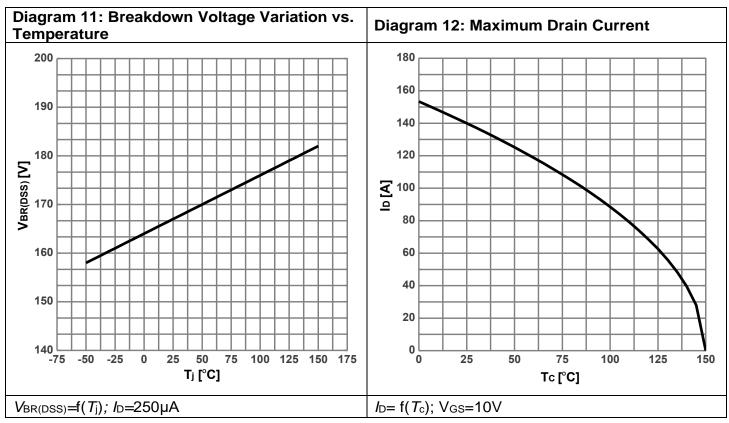




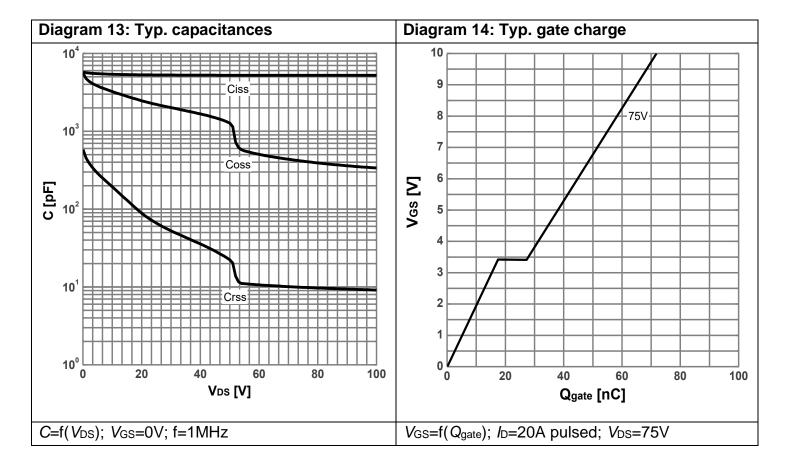






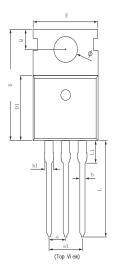




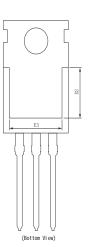




# •Dimensions (TO-220)

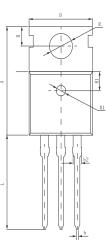


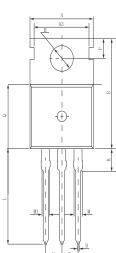




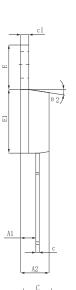
SYMBOL	MILLIMETER		
SIMDUL	MIN	Тур.	MAX
A	4. 370	4.570	4.700
A1	1.250	1.300	1.400
A2	2. 150	2.350	2.550
b	0.700	0.800	0.950
b1	1. 170	1.270	1.470
С	0.450	0.500	0.600
D	15. 100	15.600	16. 100
D1	8.800	9.100	9.400
D2	5. 500	6.300 REF	
Е	9.700	10.000	10.300
E3	7.000	7.600 REF	
е	2.540 BSC		
e1		5.080 BSC	
L	13. 200	13.500	13. 800
L1		3.100	3.400
Н	6. 250	6.500	1.352
Φ	3. 400	3.600	3.800
Q	2.600	2.800	3.000
θ 1	7° TYP		
θ2	7° TYP		
θ3	3° TYP		

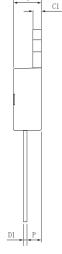


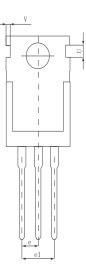


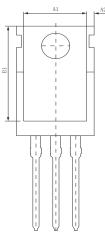












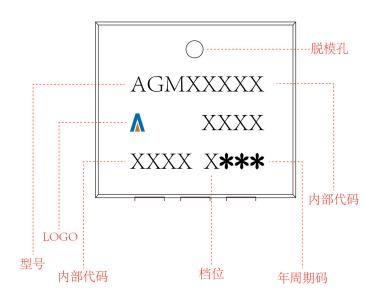
SYMBOL.		MILLIMETER	
SIMDOL	MIN	Тур.	MAX
A	15.400	15.600	15. 800
A1	2.350	2. 400	2.500
A2	4.400	4. 500	4.700
b	0.700	0.800	0.900
b2	1.180	1.310	1.440
С	0.480	0.500	0.560
c1	1.290	1.300	1.320
D	9.800	10.000	10. 200
Е	6.400	6. 500	6.600
E1	9.000	9.100	9.200
е	2. 420	2. 540	2.660
e1	4.840	5.080	5. 320
Н	2.730	2.800	2.870
H1	2.400	2. 500	2.600
L	13.020	13.370	13.720
R	3.500	3.600	3.730
R1	1.400	1.500	1.600
U	1.650	1.750	1.850
V	0.580	0.680	0.780
θ 1	2°	2.5°	3°
θ2	6.5°	7°	7.5°

Symbol	Dimensions (mm)
A	10.0±0.3
A1	8.0±0.2
A2	0.94±0.1
A3	8.7±0.1
В	15.6±0.4
B1	13.2±0.2
С	4.5±0.2
C1	1.3±0.2
D	0.8±0.2
D1	0.5±0.1
Е	10.0±0.3
F	2.8±0.1
Н	3.6±0.1
K	3.1±0.2
L	1.3±0.4
M	1.38±0.1
M1	1.28±0.1
N	2.54 (typ)
P	2.4±0.3
Q	9.15±0.25

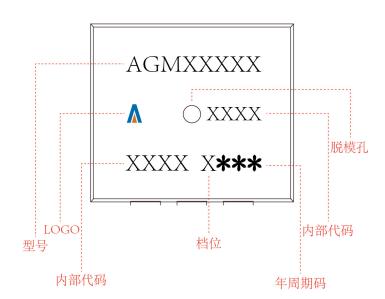


# TO-220 Marking Instructions:

# Model1:



# Model2:





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